

PXN8R3-30QL

30 V, N-channel Trench MOSFET

31 July 2023 **Product data sheet**

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic-level compatible
- Trench MOSFET technology
- Ultra low Q_G and Q_{GD} for high system efficiency, especially at higher switching frequencies
- Superfast switching with soft-recovery
- Low spiking and ringing for low EMI designs
- MLPAK33 package (3.3 x 3.3 mm footprint)

3. Applications

- DC to DC conversion
- Battery management
- Low-side load switch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

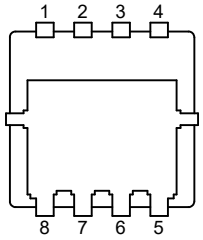
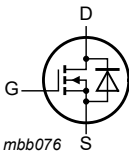
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{DS}	drain-source voltage	T_j = 25 °C		-	-	30	V
V_{GS}	gate-source voltage			-20	-	20	V
I_D	drain current	V_{GS} = 10 V; T_{amb} = 25 °C; t ≤ 5 s	[1]	-	-	18.3	A
Static characteristics							
R_{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 11.4 A; T_j = 25 °C		-	7.1	8.3	mΩ
		V_{GS} = 4.5 V; I_D = 9.8 A; T_j = 25 °C		-	8.9	11.1	mΩ
Dynamic characteristics							
$Q_{G(tot)}$	total gate charge	V_{DS} = 15 V; I_D = 9.8 A; V_{GS} = 4.5 V; T_j = 25 °C		-	5.1	7.7	nC

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm^2.

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	 MLPAK33 (SOT8002-1)	
2	S	source		
3	S	source		
4	G	gate		
5	D	drain		
6	D	drain		
7	D	drain		
8	D	drain		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PXN8R3-30QL	MLPAK33	plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1

7. Marking

Table 4. Marking codes

Type number	Marking code
PXN8R3-30QL	9AD

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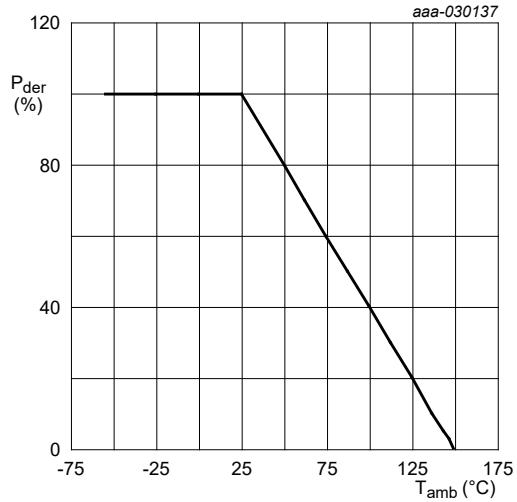
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

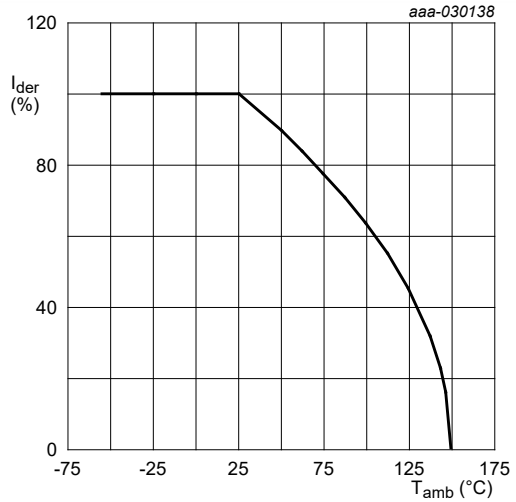
Symbol	Parameter	Conditions		Min	Max	Unit
V_{DS}	drain-source voltage	T_j = 25 °C		-	30	V
V_{GS}	gate-source voltage			-20	20	V
I_D	drain current	V_{GS} = 10 V; T_{amb} = 25 °C; t ≤ 5 s	[1]	-	18.3	A
		V_{GS} = 10 V; T_{amb} = 25 °C	[1]	-	11.4	A
		V_{GS} = 10 V; T_{amb} = 100 °C	[1]	-	7.2	A
		V_{GS} = 10 V; T_{sp} = 25 °C		-	31	A
I_{DM}	peak drain current	T_{amb} = 25 °C; single pulse; t_p ≤ 10 µs		-	293	A
P_{tot}	total power dissipation	T_{amb} = 25 °C; t ≤ 5 s	[1]	-	4.3	W
			[1]	-	1.7	W
		T_{sp} = 25 °C		-	12.5	W
T_j	junction temperature			-55	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C
Source-drain diode						
I_S	source current	T_{amb} = 25 °C	[1]	-	1.5	A
Avalanche ruggedness						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$T_{j(init)}$ = 25 °C; I_D = 1.7 A; DUT in avalanche (unclamped)		-	25	mJ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm^2.



$$P_{der} = \frac{P_{tot}}{P_{tot(25\,°C)}} \times 100\,\%$$

Fig. 1. Normalized total power dissipation as a function of ambient temperature



$$I_{der} = \frac{I_D}{I_{D(25\,°C)}} \times 100\,\%$$

Fig. 2. Normalized continuous drain current as a function of ambient temperature

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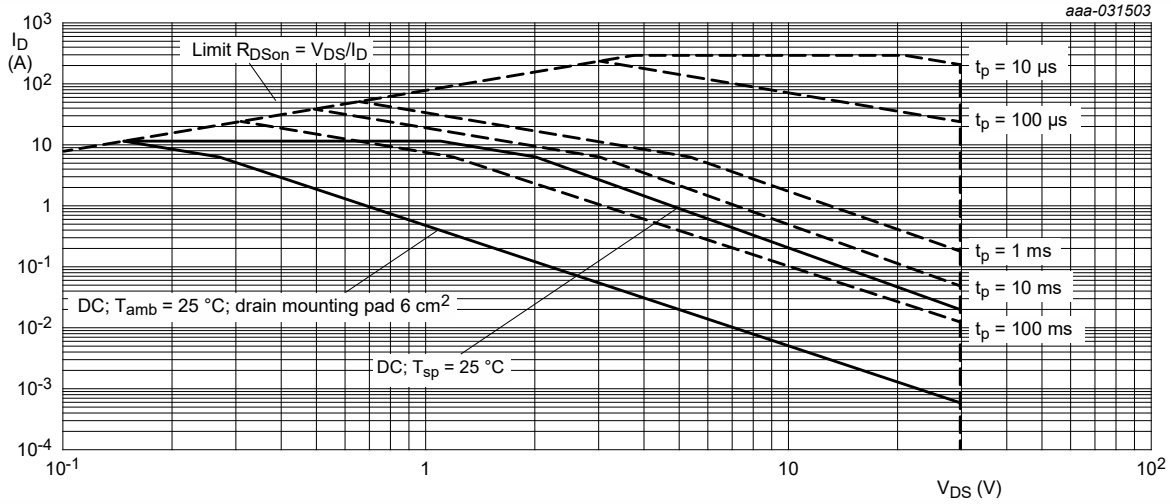


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

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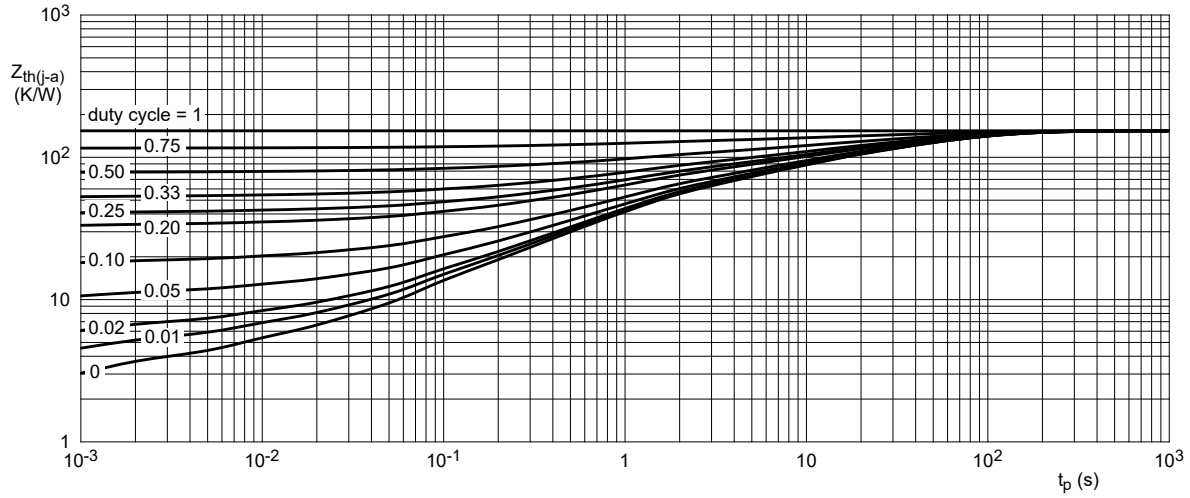
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9. Thermal characteristics

Table 6. Thermal characteristics

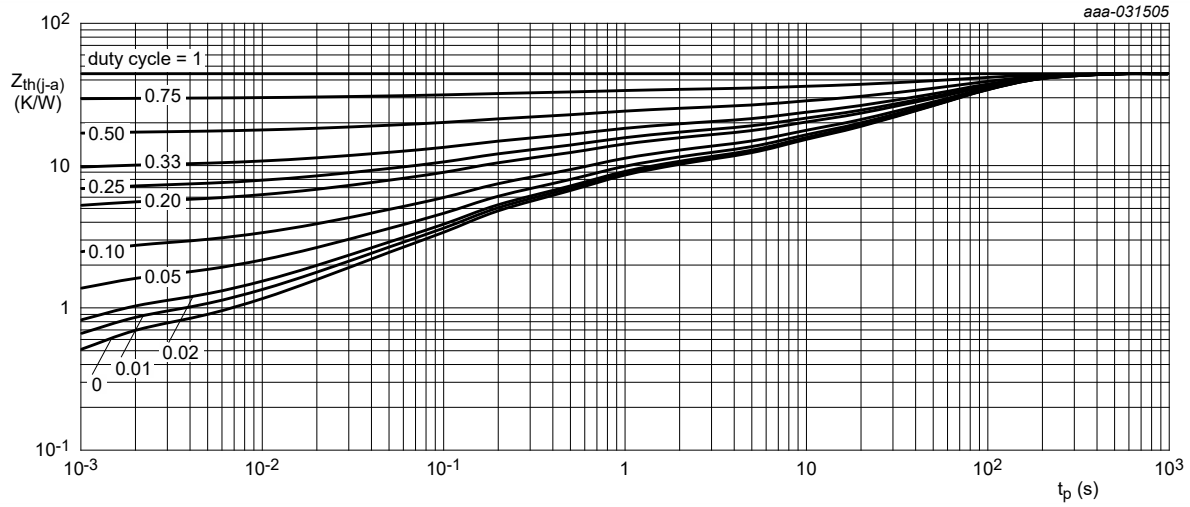
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	150	190	K/W
			[2]	-	60	75	K/W
		in free air; t ≤ 5 s	[2]	-	24	29	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	7	10	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm^2.



FR4 PCB, standard footprint

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for drain 6 cm^2

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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10. Characteristics

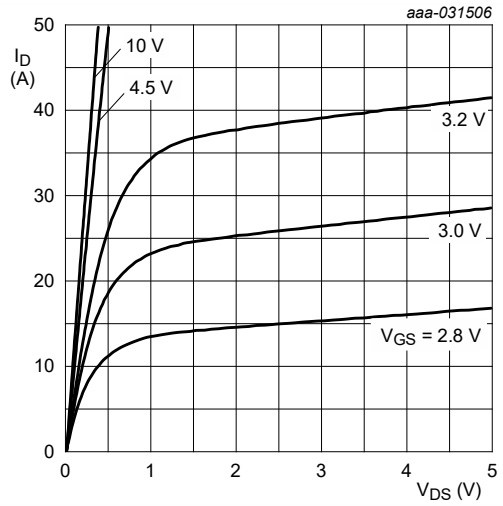
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
$V_{(BR)DSS}$	drain-source breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C		30	-	-	V
V_{GSth}	gate-source threshold voltage	I_D = 250 µA; V_{DS} = V_{GS}; T_j = 25 °C		1.2	1.7	2.2	V
I_{DSS}	drain leakage current	V_{DS} = 30 V; V_{GS} = 0 V; T_j = 25 °C		-	-	1	µA
I_{GSS}	gate leakage current	V_{GS} = 20 V; V_{DS} = 0 V; T_j = 25 °C		-	-	0.1	µA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C		-	-	-0.1	µA
R_{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 11.4 A; T_j = 25 °C		-	7.1	8.3	mΩ
		V_{GS} = 10 V; I_D = 11.4 A; T_j = 150 °C		-	11	12.9	mΩ
		V_{GS} = 4.5 V; I_D = 9.8 A; T_j = 25 °C		-	8.9	11.1	mΩ
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 11.4 A; T_j = 25 °C		-	25	-	S
R_G	gate resistance	f = 1 MHz		-	2.3	-	Ω
Dynamic characteristics							
$Q_{G(tot)}$	total gate charge	V_{DS} = 15 V; I_D = 11.4 A; V_{GS} = 10 V; T_j = 25 °C		-	10.6	15.9	nC
		V_{DS} = 15 V; I_D = 9.8 A; V_{GS} = 4.5 V; T_j = 25 °C		-	5.1	7.7	nC
Q_{GS}	gate-source charge			-	1.9	-	nC
$Q_{GS(th)}$	pre-threshold gate-source charge			-	1.2	-	nC
$Q_{GS(th-pl)}$	post-threshold gate-source charge			-	0.7	-	nC
Q_{GD}	gate-drain charge			-	1.3	-	nC
V_{GSpl}	gate-source plateau voltage	V_{DS} = 15 V; I_D = 9.8 A; T_j = 25 °C		-	2.6	-	V
C_{iss}	input capacitance	V_{DS} = 15 V; f = 1 MHz; V_{GS} = 0 V; T_j = 25 °C		-	760	-	pF
C_{oss}	output capacitance			-	270	-	pF
C_{rss}	reverse transfer capacitance			-	42	-	pF
$t_{d(on)}$	turn-on delay time	V_{DS} = 15 V; I_D = 9.8 A; V_{GS} = 4.5 V; $R_{G(ext)}$ = 5 Ω; T_j = 25 °C		-	5	-	ns
t_r	rise time			-	8	-	ns
$t_{d(off)}$	turn-off delay time			-	6	-	ns
t_f	fall time			-	3	-	ns
Source-drain diode							
V_{SD}	source-drain voltage	I_S = 1.5 A; V_{GS} = 0 V; T_j = 25 °C		-	0.7	1.2	V
t_{rr}	reverse recovery time	I_S = 1.5 A; dI_S/dt = -100 A/µs; V_{GS} = 4.5 V; V_{DS} = 15 V; T_j = 25 °C		-	15	-	ns
Q_r	recovered charge			-	6	-	nC
t_a	reverse recovery rise time			-	8	-	ns
t_b	reverse recovery fall time			-	7	-	ns

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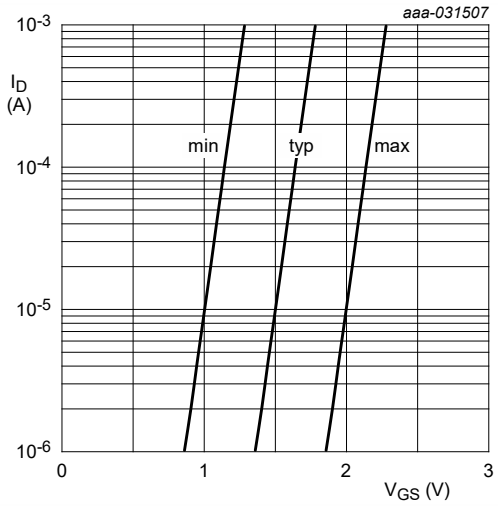
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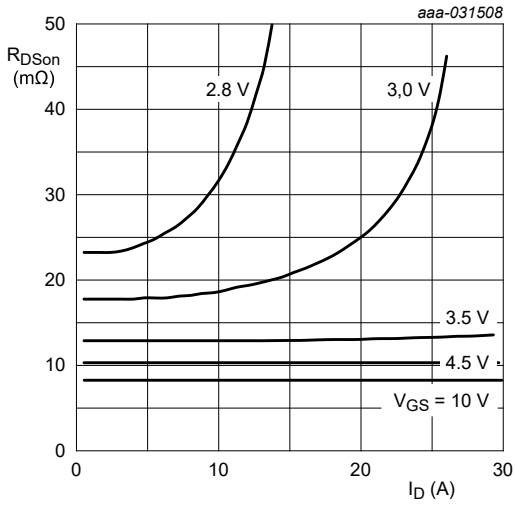
T_j = 25 °C

Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values



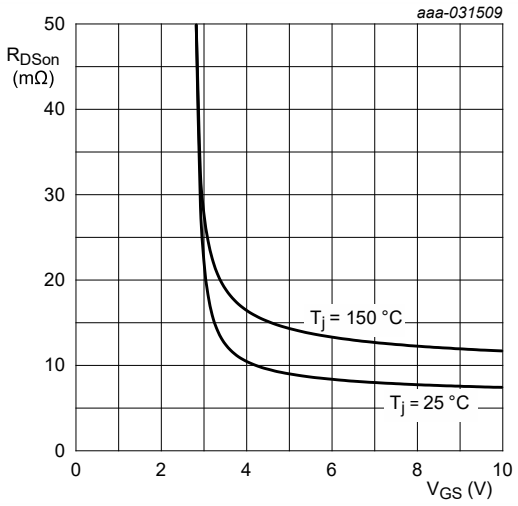
T_j = 25 °C; V_{DS} = 5 V

Fig. 7. Subthreshold drain current as a function of gate-source voltage



T_j = 25 °C

Fig. 8. Drain-source on-state resistance as a function of drain current; typical values



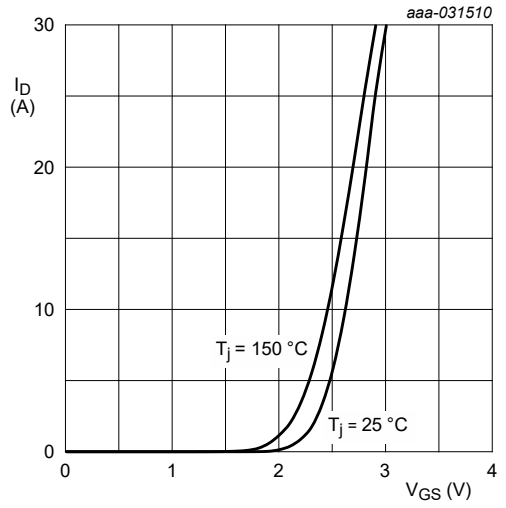
I_D = 11.4 A

Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

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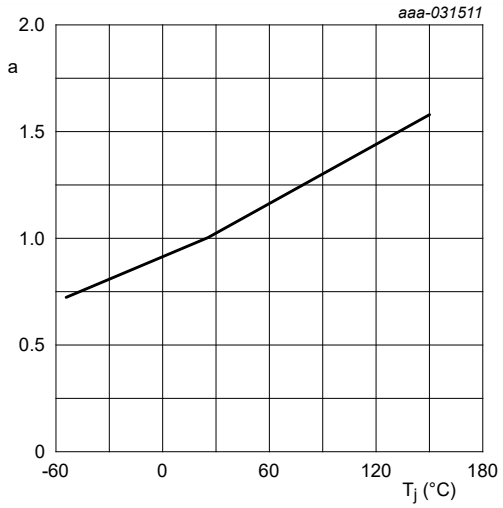
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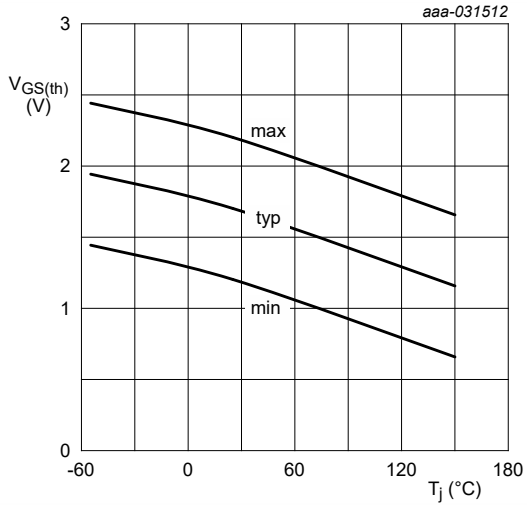
V_{DS} = 10 V

Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values



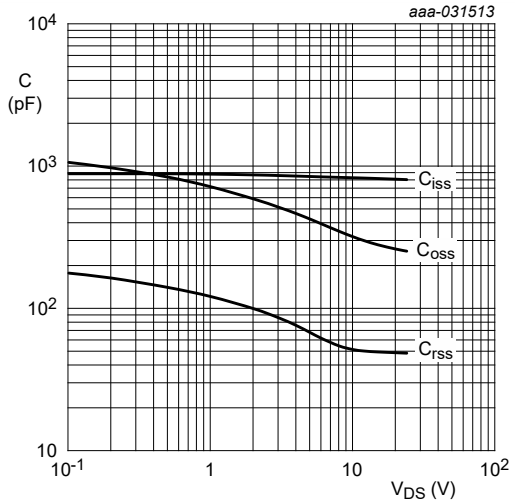
$$a = \frac{R_{DSon}}{R_{DSon(25°C)}}$$

Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values



I_D = 250 µA; V_{DS} = V_{GS}

Fig. 12. Gate-source threshold voltage as a function of junction temperature



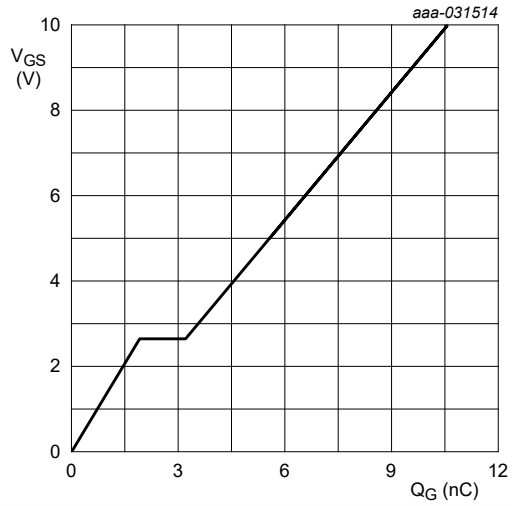
f = 1 MHz; V_{GS} = 0 V

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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I_D = 9.8 A; V_{DS} =15 V; T_j = 25 °C

Fig. 14. Gate-source voltage as a function of gate charge; typical values

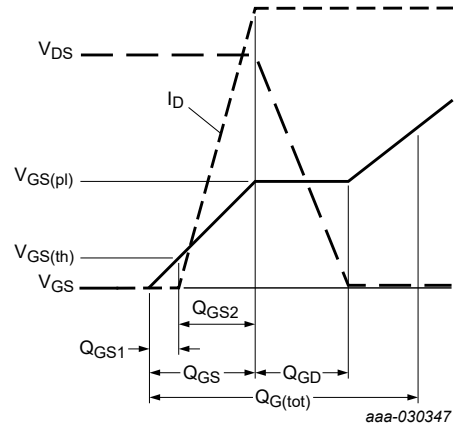


Fig. 15. Gate charge waveform definitions

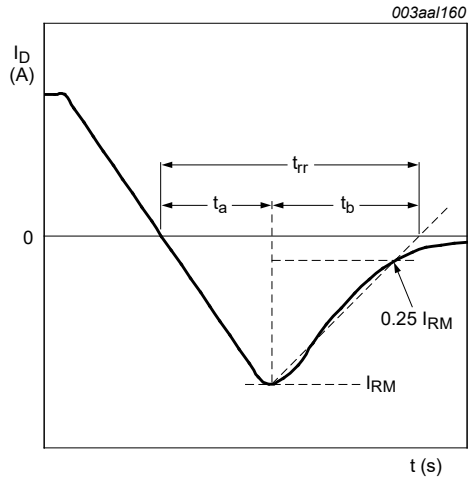
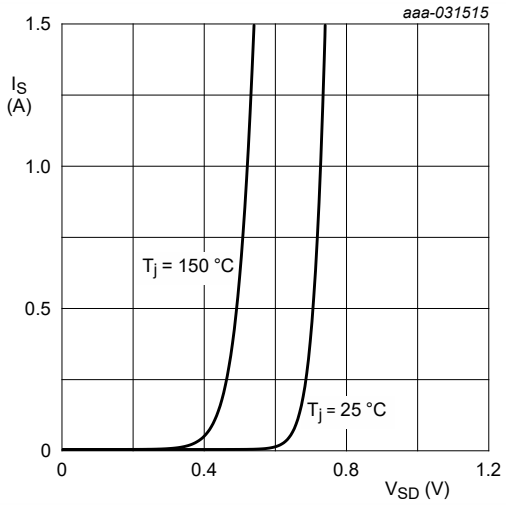


Fig. 16. Reverse recovery timing definition



V_{GS} = 0 V

Fig. 17. Source current as a function of source-drain voltage; typical values

11. Test information

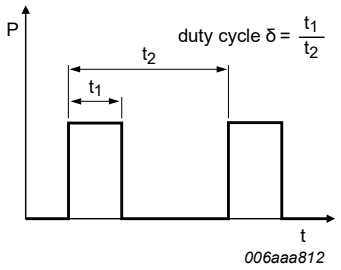


Fig. 18. Duty cycle definition

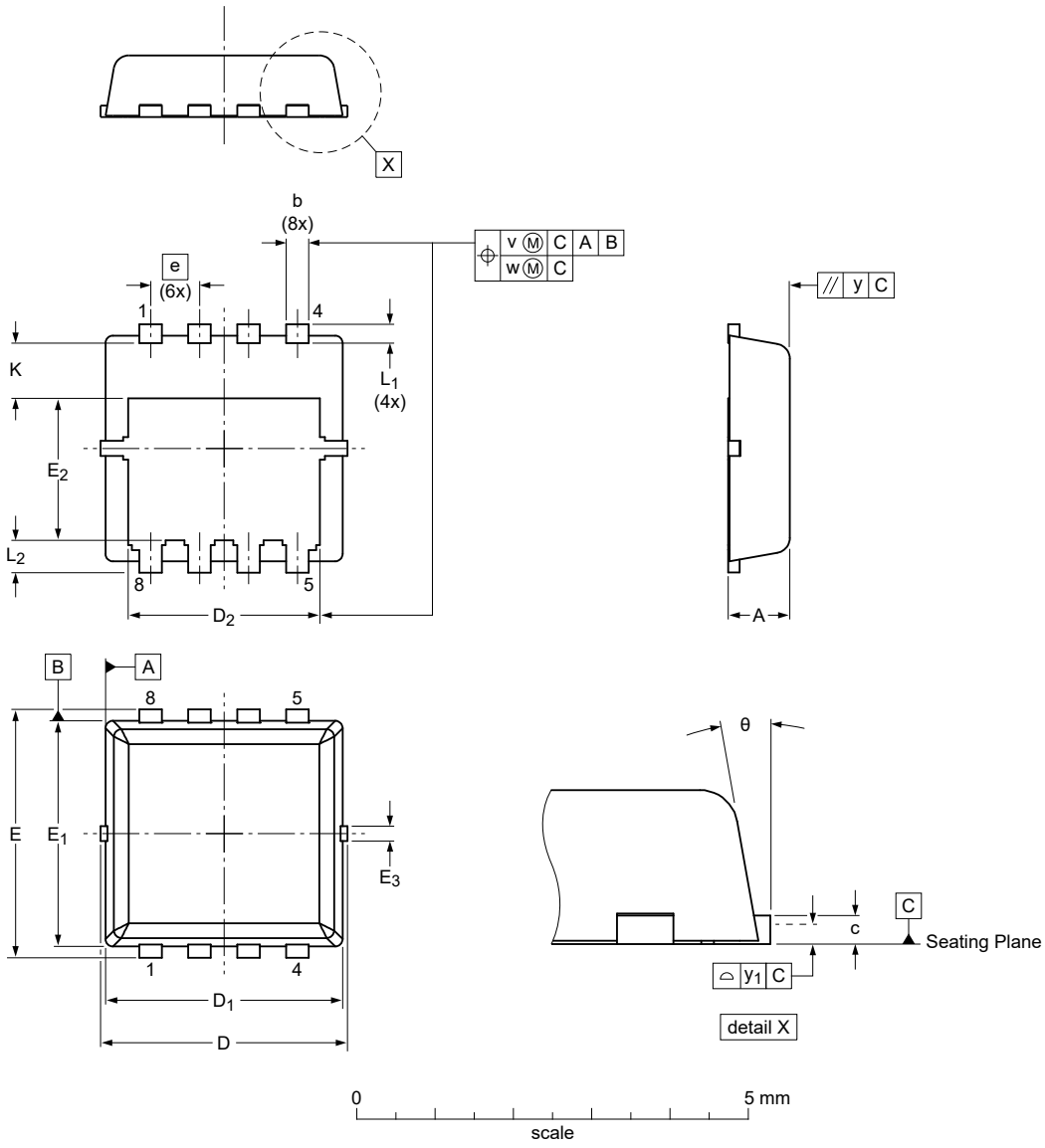
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12. Package outline

MLPAK33: plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body **SOT8002-1**



Dimensions (mm are the original dimensions)

Unit		A	b	c	D	D_1	D_2	e	E	E_1	E_2	E_3	K	L_1	L_2	θ	y	y_1	v	w
mm	max	0.90	0.35	0.18	3.50	3.25	2.65		3.50	3.10	1.99	0.25		0.40	0.58	12°				
	nom	0.80	0.30	0.15	3.30	3.15	2.55	0.65	3.30	3.00	1.89	0.20	0.65 (ref)	0.25	0.43	10°	0.05	0.05	0.1	0.05
	min	0.70	0.25	0.12	3.10	3.05	2.45		3.10	2.90	1.79	0.15		0.10	0.28	8°				

sot8002-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	EIAJ			
SOT8002-1						~~20-01-19~~ 23-05-17

Fig. 19. Package outline MLPAK33 (SOT8002-1)

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13. Soldering

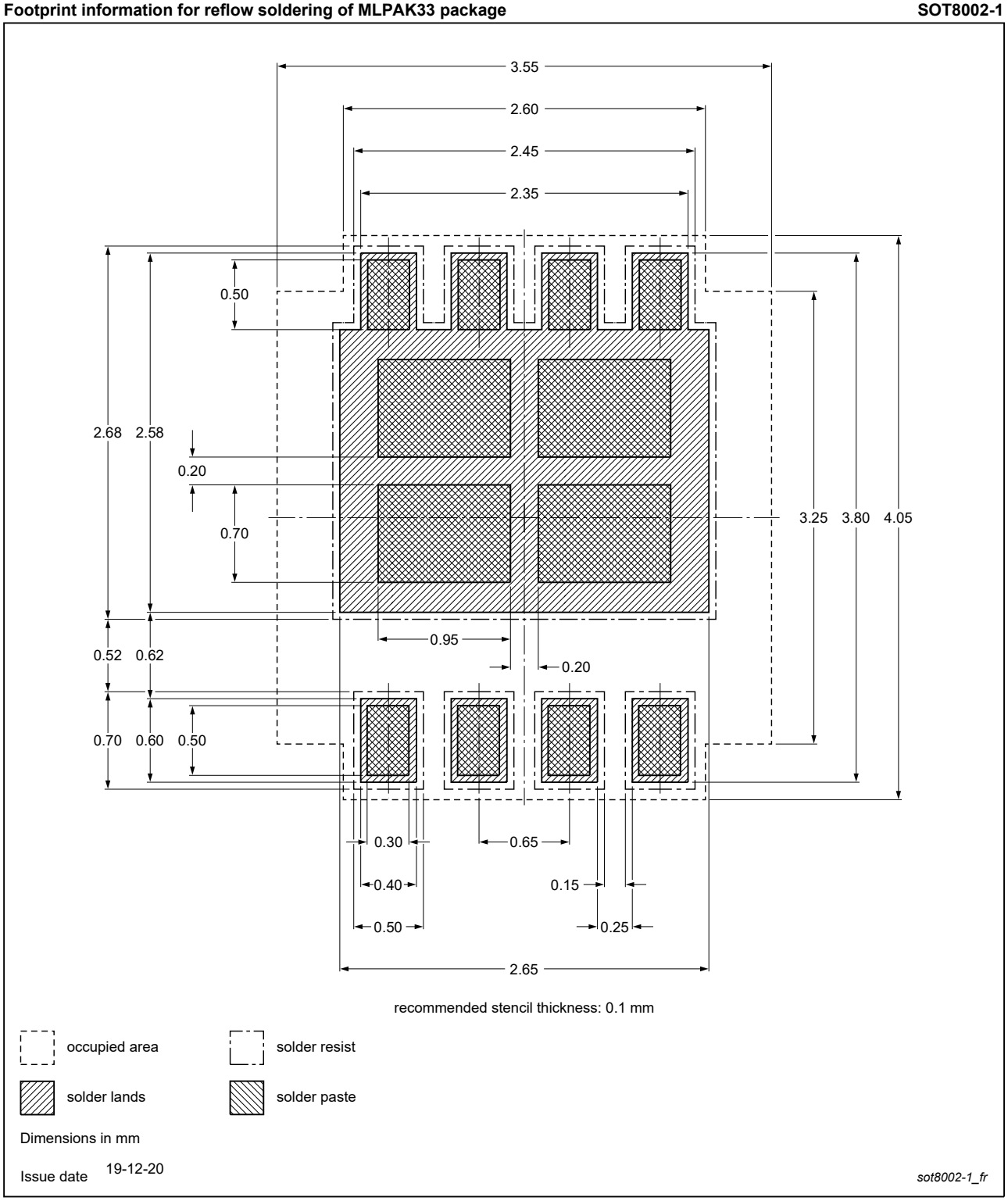


Fig. 20. Reflow soldering footprint for MLPAK33 (SOT8002-1)

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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PXN8R3-30QL v.3	20230731	Product data sheet	-	PXN8R3-30QL v.2
Modifications:	• Chapter "Package outline": drawing update			
PXN8R3-30QL v.2	20201102	Product data sheet	-	PXN8R3-30QL v.1
PXN8R3-30QL v.1	20200428	Preliminary data sheet	-	-

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Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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